TDA8444

GENERAL DESCRIPTION

The TDA8444 comprises eight digital-to-analogue converters (DACs) each controlled via the two-wire l^2C -bus. The DACs are individually programmed using a 6-bit word to select an output from one of 64 voltage steps. The maximum output voltage of all DACs is set by the input V_{max} and the resolution is approximately $V_{max}/64$.

At power-on all DAC outputs are set to their lowest value. The I²C-bus slave receiver has a 7-bit address of which 3 bits are programmable via pins A0, A1 and A2.

Features

- · Eight discrete DACs
- I²C-bus slave receiver
- 16-pin DIL package.

QUICK REFERENCE DATA

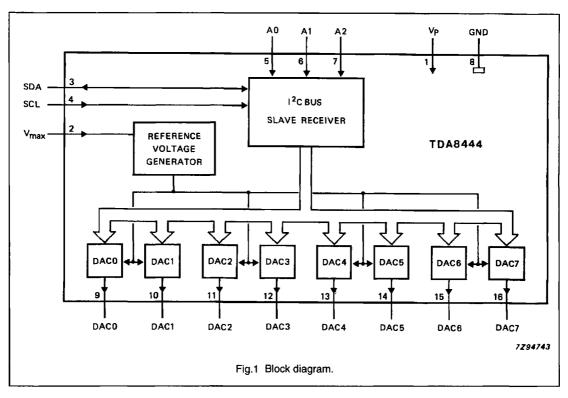
PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V _P	10.8	12.0	13.2	V
Supply current	no loads; V _{max} = V _P ;					
	all data = 00	Icc	8	12	15	mA
Total power dissipation	no loads; V _{max} = V _P ;	ŧ				
	all data = 00	P _{tot}	-	150	-	mW
Effective range of						
V _{max} input	V _P = 12 V	V_{max}	1	-	10.5	v
DAC output voltage			}			
range		$ v_{o} $	0.1	_	V _P -0.5	v
Step value of 1 LSB	$V_{max} = V_{P};$	ľ				
	$V_{\text{max}} = V_{\text{P}};$ $I_{\text{O}} = -2 \text{ mA}$	V_{LSB}	70	160	250	mV

PACKAGE OUTLINE

16-lead DIL; plastic (SOT38); SOT38-1; 1996 July 23.

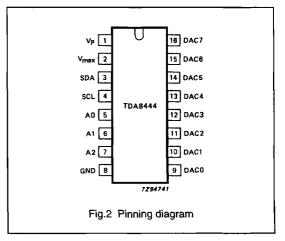


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PINNING

PIN	SYMBOL	DESCRIPTION				
1	V _P	positive supply voltage				
2	V _{max}	control input for DAC maximum output voltage				
3	SDA	I ² C-bus serial data input/output				
4	SCL	I ² C-bus serial data clock				
5	A0	la add a late				
6	A1	programmable address bits for I ² C-bus slave receiver				
7	A2	- IOI 1 O-DUS SIAVE IECEIVEI				
8	GND	ground				
9-16	DAC0-7	analogue voltage outputs				



Philips Semiconductors Product specification

Octuple 6-bit DAC with I²C-bus

TDA8444

FUNCTIONAL DESCRIPTION

I²C-bus

The TDA8444 I2C-bus interface is a receive-only slave. Data is accepted from the I2C-bus in the following format:

S	0	1	0	0	A 2	A 1	A0	0	Α	13	12	11	10	SD	SC	SB	SA	Α	Х	Х	D5	D4	DЗ	D2	D1	D0	Α	P
	<		ac	ldre	ss b	yte		>		\		inst	ructi	ion b	yte		·-		<		first	data	a by	te		·->		
W	ere:																											
Ş	=	star	t cor	diti	on									A2,	A1,	Α0				=	prog	gran	nma	ble a	ıddr	ess I	oits	
Р	=	stop	cor	diti	on									13, I	2, 11	, 10				=	insti	ructi	on b	oits				
Α	=	ack	nowl	edg	je									SD,	sc	, SB	, SA			=	sub	addı	ress	bits				
Χ	=	don	't ca	re										D5,	D4,	D3,	D2,	D1,	D0	=	data	a bits	ŝ					

Fig.3 Data format.

Address byte

Valid addresses are 40, 42, 44, 46, 48, 4A, 4C, 4E (hexadec), depending on the programming of bits A2, A1 and A0. With these addresses, up to eight TDA8444 ICs can be operated independently from one I²C-bus. No other addresses are acknowledged by the TDA8444.

Instruction and data bytes

Valid instructions are 00 to 0F and F0 to FF (hexadec); the TDA8444 will not respond to other instruction values.

Instructions 00 to 0F cause auto-incrementing of the subaddress (bits SD to SA) when more than one data byte is sent within one transmission. With auto-incrementing, the first data byte is written into the DAC addressed by bits SD to SA and then the subaddress is automatically incremented by one position for the next data byte in the series.

Auto-incrementation does not occur with instructions F0 to FF. Other than auto-incrementation there is no difference between instructions 00 to 0F and F0 to FF. When only one data byte per transmission is present, the DAC addressed by the subaddress will always receive the data.

Valid subaddresses (bits SD to SA) are 0 to 7 (hexadec) relating numerically to DAC0 to DAC7. When the auto-incrementing function is used, the subaddress will sequence through all possible values (0 to F, 0 to F, etc.).

I²C-bus

Input SCL (pin 3) and input/output SDA (pin 4) conform to I²C-bus specifications. Pins 3 and 4 are protected against positive voltage pulses by internal zener diodes connected to the ground plane and therefore the normal bus line voltage should not exceed 5.5 V.

The address inputs A0, A1, A2 are programmed by a connection to GND for An = 0 or to V_P for An = 1. If the inputs are left floating, An = 1 will result.

Octuple 6-bit DAC with I2C-bus

TDA8444

Input V_{max}

Input V_{max} (pin 2) provides a means of compressing the output voltage swing of the DACs. The maximum DAC output voltage is restricted to approximately V_{max} while the 6-bit resolution is maintained, so giving a finer voltage resolution of smaller output swings.

Digital-to-analogue converters

Each DAC comprises a 6-bit data latch, current switches and an output driver. Current sources with values weighted by 2^0 up to 2^5 are switched according to the data input so that the sum of the selected currents gives the required analogue voltage from the output driver. The range of the output voltage is approximately 0.5 to 10.5 V when $V_{max} = V_P$.

The DAC outputs are protected against short-circuits to VP and GND.

To avoid the possibility of oscillations, capacitive loading at the DAC outputs should not exceed 2 nF.

RATINGS
Limiting values in accordance with the Absolute Maximum System (IEC 134)

PARAMETER	SYMBOL	MIN.	MAX.	UNIT
Supply voltage	$V_P = V_1$	-0.5	18	V
Supply current (source)	t _P = I ₁	-	-10	mA
	lp = l1	-	40	mA
I2C-bus line voltage	V _{3,4}	-0.5	5.9	V
Input voltage	$ v_i $	0.5	V _P + 0.5	V
Output voltage	v _o	-0.5	V _P + 0.5	V
Maximum current on any pin (except pins 1 and 8)	±I _{max}	-	10	mA
Total power dissipation	P _{tot}		500	mW
Operating ambient temperature range	T _{amb}	20	+70	°C
Storage temperature range	T _{stg}	-55	+150	°C

THERMAL RESISTANCE

From junction to ambient Rth j-a 75 K/W

TDA8444

CHARACTERISTICS

All voltages are with respect to GND; $T_{amb} = 25 \, ^{\circ}\text{C}$; $V_{P} = 12 \, \text{V}$ unless otherwise specified

PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V _P	10.8	12.0	13.2	v
Voltage level for power-on reset		V ₁	1	-	4.8	V
Supply current	no loads; V _{max} = V _P ; all data = 00	I _P = I ₁	8	12	15	mA
Total power dissipation	no loads; V _{max} = V _P ; all data = 00	P _{tot}	-	150	_	mW
Effective range of V _{max} input (pin 2)	V _P = 12 V	$V_{max} = V_2$	1.0	-	10.5	V
Pin 2 current	V ₂ = 1 V	l ₂	_	_	-10	μА
	$V_2 = VP$	l ₂	_	_	10	μА
SDA, SCL inputs (pins 3 ar	nd 4)					•
Input voltage range		$ v_i $	0	_	5.5	V
Input voltage LOW		V _{IL}	_	-	1.5	V
Input voltage HIGH		V _{IH}	3.0	_	_	v
Input current LOW	$V_{3;4} = 0.3 \text{ V}$	I _{IL}	-	_	-10	μА
Input current HIGH	$V_{3;4} = 6 V$	I _{IH}	-	_	±10	μА
SDA output (pin 3)						
Output voltage LOW	$I_3 = 3 \text{ mA}$	V _{OL}	-	_	0.4	V
Sink current		1 _{OL}	3	8	-	mA
Address inputs (pins 5 to 7	")		•	•	,	•
Input voltage range		$ v_i $	0		5	lv
Input voltage LOW		V _{IL}	_	_	1	v
Input voltage HIGH		V _{IH}	2.1	_	_	v
Input current LOW		կլ	_	 7	-12	μΑ
Input current HIGH		I _{IH}	_	-	1	μΑ

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PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
DAC outputs (pins 9 to 16)						
Output voltage range		vo	0.1	-	$V_{P} - 0.5$	v
Minimum output voltage	data = 00; I _O = -2 mA	VOmin	0.1	0.4	0.8	v
Maximum output voltage	data = 3F; $I_0 = -2 \text{ mA}$					
at Vmax = VP		V _{Omax}	10	10.5	11.5	v
at 1 < Vmax < 10.5 V		V _{Omax}		see note 1	, 	v
Output sink current	V = V _P ; data = 1F	l _o	2	8	15	mA
Output source current	V = 0 V; data = 1F	10	-2	-	-6	mA
Output impedance	data = 1F; -2 < I _O < +2 mA	z _o	_	4	50	Ω
Step value of 1 LSB	$V_{max} = V_P; I_O = -2 \text{ mA}$	V _{LSB}	70	160	250	mV
Deviation from linearity	$I_0 = -2 \text{ mA}; N \neq 32$	1	0	_	50	mV
Deviation from linearity	$I_0 = -2 \text{ mA}; N = 32$		0	_	70	mV

Note to the Characteristics

^{1.} $V_O = 0.95 V_{max} + V_{Omin}$.

TDA8444

APPLICATION INFORMATION

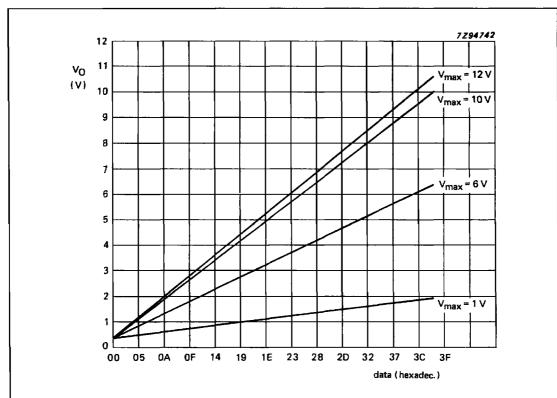


Fig.4 Graph showing output voltage as a function of the input data value for V_{max} values of 1, 6, 10 and 12 V; $V_P = 12 \text{ V}$.